Product Information

Ultramid[®] Structure B3WG8 LF BK564 Polyamide 6



Product Description

Ultramid Structure B3WG8 LF BK564 is a long glass-fiber fiber reinforced and heat aging resistant injection molding grade designed for applications requiring excellent strength and stiffness.

PHYSICAL	ISO Test Method	Property Value	
Density, g/cm	1183	1.46	
Mold Shrinkage, parallel, %	294-4	0.27	
Mold Shrinkage, normal, %	294-4	0.59	
MECHANICAL	ISO Test Method	Dry	Conditioned
Tensile Modulus, MPa	527		
23C		13,300	9,500
80C		8,000	-
Tensile stress at break, MPa	527		
23C		220	130
80C		121	-
Tensile strain at break, %	527		
23C		2.1	2.3
Flexural Strength, MPa	178		
23C		316	218
Flexural Modulus, MPa	178		
23C		11,700	8,800
ІМРАСТ	ISO Test Method	Dry	Conditioned
Izod Notched Impact, kJ/m ²	180		
23C		26	25
Charpy Notched, kJ/m ²	179		
23C		26	26
-30C		26	26
Charpy Unnotched, kJ/m ²	179		
23C		76	83
-30C		58	61
THERMAL	ISO Test Method	Dry	Conditioned
Melting Point, C	3146	220	-
HDT A, C	75	218	-





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Melt Temperature 290-300 degC (554-572 degF) Mold Temperature 80-100 degC (176-212 degF) Injection and Packing Pressure 35-125 bar (500-1500 psi)

Mold Temperatures

A mold temperature of 80-100 degC (176-212 degF) is recommended.

Pressures

Injection pressure controls the filling of the part and should be applied for 90% of ram travel. Packing pressure affects the final part and can be used effectively in controlling sink marks and shrinkage. It should be applied and maintained until the gate area is completely frozen off.

Back pressure can be utilized to provide uniform melt consistency and reduce trapped air and gas. Minimal back pressure should be utilized to prevent glass breakage.

Fill Rate

Fast fill rates are recommended to ensure uniform melt delivery to the cavity and prevent premature freezing. Surface appearance is directly affected by injection rate.

Note

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